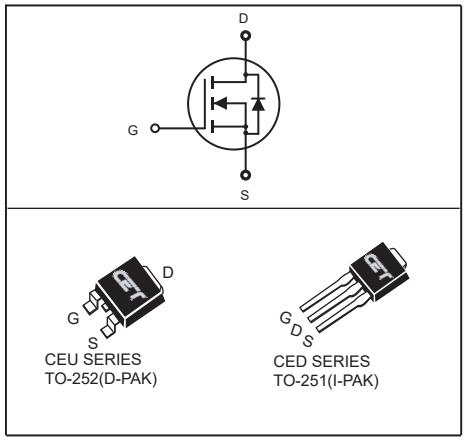
CED83A3A/CEU83A3A

N-Channel Enhancement Mode Field Effect Transistor

FEATURES

V_{DSS}	$R_{DS(ON)\ typ}$ @V_{GS}	I_D
30V	1.9mΩ@V_{GS} = 10V	135A

- High power and current handing capability.
- Reliable and rugged.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.
- 100% Avalanche tested



APPLICATIONS

- Uninterruptible Power Supply .
- Battery Management System .
- Inverter .
- Motor control .

ABSOLUTE MAXIMUM RATINGS T_C = 25°C unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous @ T_C = 25°C	I_D	135	A
@ T_C = 70°C		113	A
Drain Current-Pulsed [a]	I_{DM}	540	A
Maximum Power Dissipation @ T_C = 25°C	P_D	83	W
- Derate above 25°C		0.55	W/°C
Single Pulsed Avalanche Energy [d]	E_{AS}	612	mJ
Single Pulsed Avalanche Current [d]	I_{AS}	35	A
Operating and Store Temperature Range	T_J,T_{stg}	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.8	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	°C/W

Electrical Characteristics T_C = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS} = 0V, I_D = 250μA	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 30V, V_{GS} = 0V			1	μA
Gate Body Leakage Current, Forward	I_{GSSF}	V_{GS} = 20V, V_{DS} = 0V			100	nA
Gate Body Leakage Current, Reverse	I_{GSSR}	V_{GS} = -20V, V_{DS} = 0V			-100	nA
On Characteristics [b]						
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS} = V_{DS}, I_D = 250μA	1		3	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS} = 10V, I_D = 20A		1.9	2.3	mΩ
		V_{GS} = 4.5V, I_D = 20A		2.4	3.1	mΩ
Gate Input Resistance	R_g	f=1MHz,open Drain		0.8		Ω
Dynamic Characteristics [c]						
Input Capacitance	C_{iss}	V_{DS} = 15V, V_{GS} = 0V, f = 1.0 MHz		8490		pF
Output Capacitance	C_{oss}			885		pF
Reverse Transfer Capacitance	C_{rss}			715		pF
Switching Characteristics [c]						
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 15V, I_D = 1A, V_{GS} = 10V, R_{GEN} = 6Ω		30		ns
Turn-On Rise Time	t_r			14		ns
Turn-Off Delay Time	$t_{d(off)}$			155		ns
Turn-Off Fall Time	t_f			57		ns
Total Gate Charge	Q_g	V_{DS} = 15V, I_D = 16A, V_{GS} = 5V		74		nC
Gate-Source Charge	Q_{gs}			16		nC
Gate-Drain Charge	Q_{gd}			29		nC
Drain-Source Diode Characteristics and Maximun Ratings						
Drain-Source Diode Current-Continuous	I_S				97	A
Drain-Source Diode Current-Pulsed [b]	I_{SM}				540	A
Drain-Source Diode Forward Voltage [b]	V_{SD}	V_{GS} = 0V, I_S = 10A			1.2	V

Notes :
a.Repetitive Rating : Pulse width limited by maximum junction temperature.
b.Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
c.Guaranteed by design, not subject to production testing.
d.L = 1mH, I_{AS} = 35A, V_{DD} = 24V, R_G = 25Ω, Starting T_J = 25°C.

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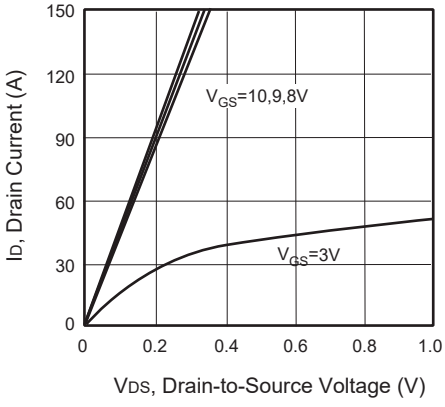

Figure 1. Output Characteristics

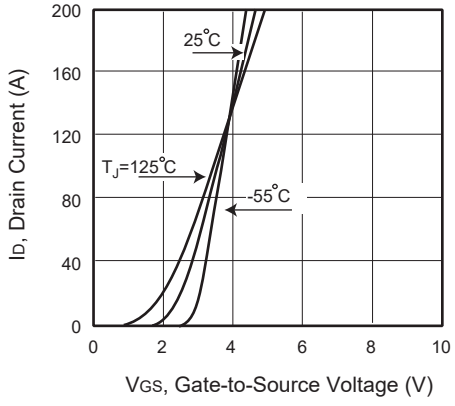

Figure 2. Transfer Characteristics

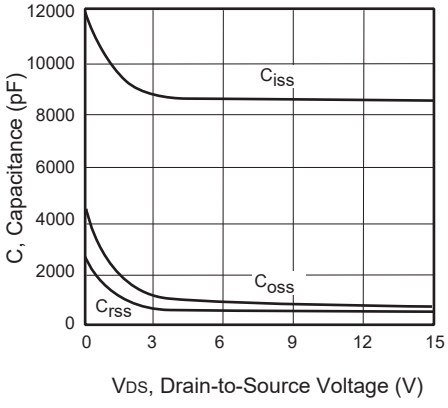

Figure 3. Capacitance

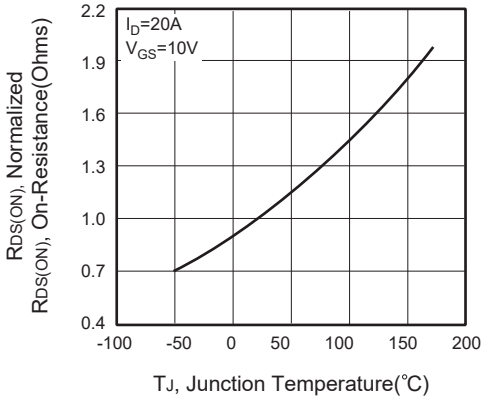

Figure 4. On-Resistance Variation with Temperature

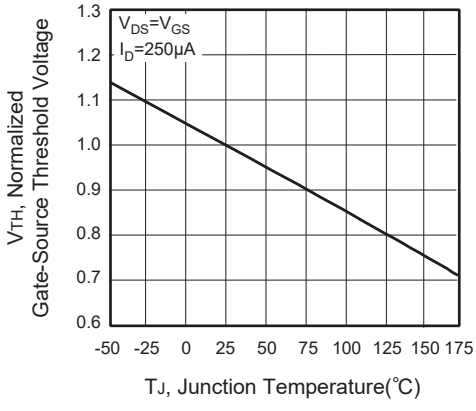

Figure 5. Gate Threshold Variation with Temperature

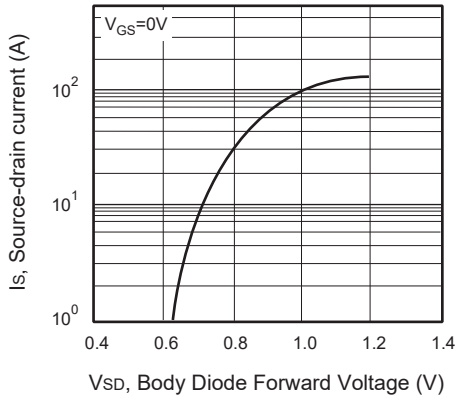

Figure 6. Body Diode Forward Voltage Variation with Source Current

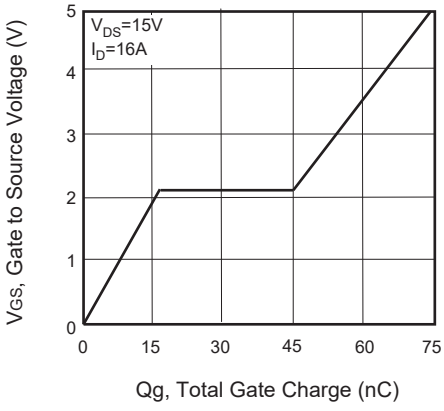

Figure 7. Gate Charge

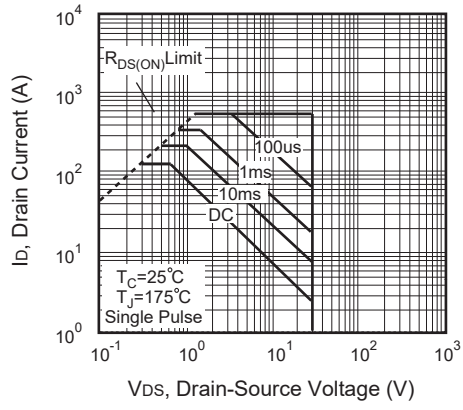

Figure 8. Maximum Safe Operating Area

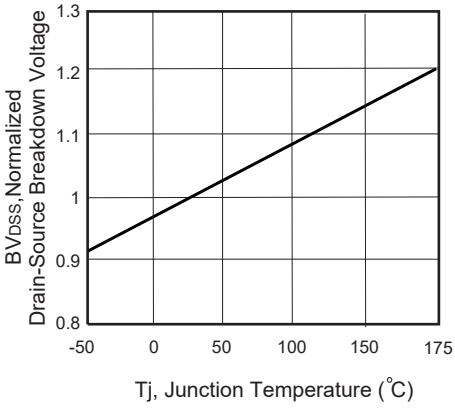

Figure 9. Breakdown Voltage Variation VS Temperature

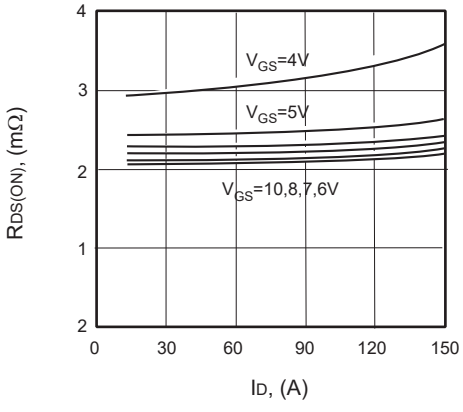

Figure 10. On-Resistance vs. Drain Current

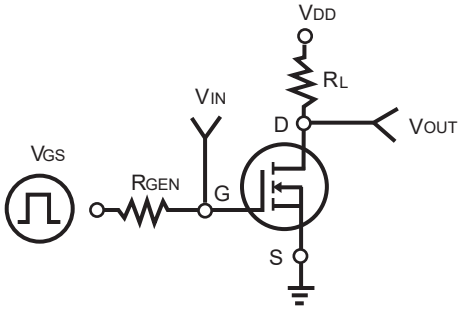

Figure 11. Switching Test Circuit

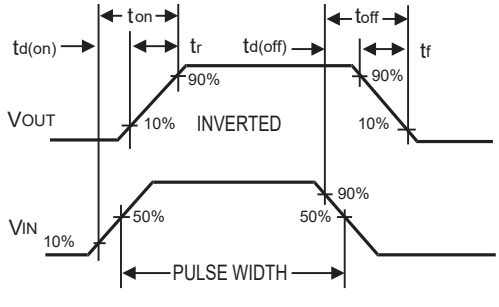

Figure 12. Switching Waveforms

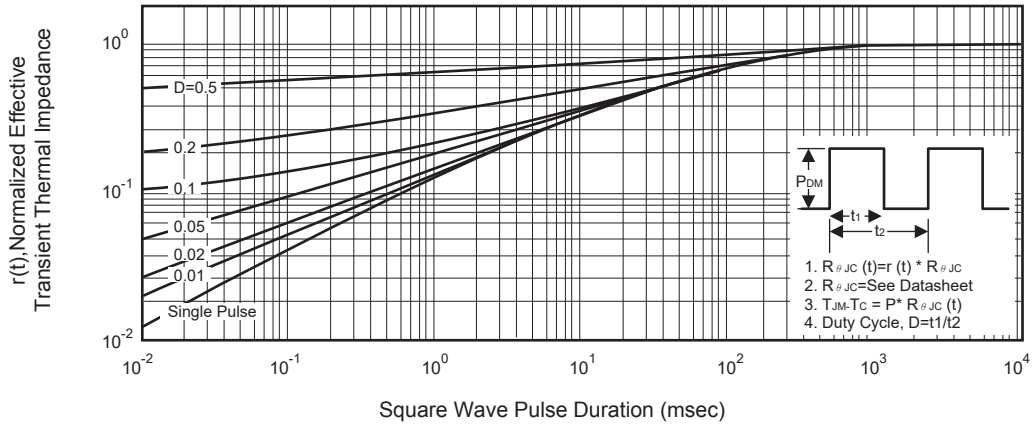

Figure 13. Normalized Thermal Transient Impedance Curve